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**Amendments to the Claims:**

1. (previously presented) A curable composition that is controllably curable by microwave energy comprising:
  - a) at least one heat curable resin component;
  - b) microwave absorbable particles having a Curie temperature at or above the cure temperature of said heat curable resin component and below the degradation temperature of said heat curable resin component and said particles being present in an amount greater than 10% by weight of said composition; and
  - c) at least one curing agent for said heat curable resin component.
2. (original) A composition according to claim 1 wherein said microwave absorbable particles are in an amount sufficient to uniformly cure said composition.
3. (previously presented) A composition according to claim 1 wherein said microwave absorbable particles are in an amount greater than 10% to about 40% by weight of said composition.
4. (original) A composition according to claim 1 wherein said microwave absorbable particles are selected so that the Curie temperature of said particles is higher than the curing temperature of said heat curable resin component.
5. (original) A composition according to claim 1 wherein said microwave absorbable particles comprise a ferromagnetic compound.
6. (original) A composition according to claim 1 wherein said microwave absorbable particles are selected from the group consisting of ferrite, amorphous carbon, carbon black, graphite and combinations thereof.
7. (previously presented) A composition according to claim 1 wherein said curable resin component is selected from the group consisting of acrylics, elastomeric synthetic rubbers,